Approved by:

Checked by:

Issued by:

# **SPECIFICATION**

PRODUCT: SAW FILTER

MODEL: HDF422C S4



SHOULDER ELECTRONICS LIMITED

# 1. SCOPE

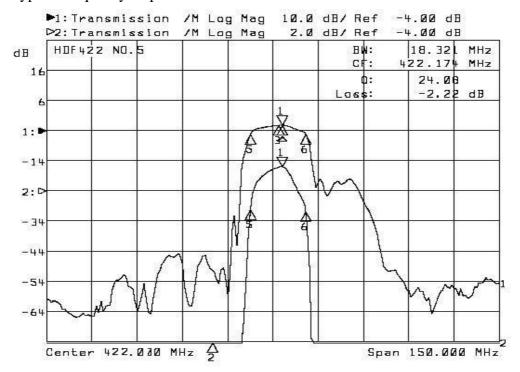
This specification shall cover the characteristics of SAW filter With 422M used for the page system.

# 2. ELECTRICAL SPECIFICATION

| DC Voltage VDC        | 0V             |
|-----------------------|----------------|
| AC Voltage Vpp        | 10V50Hz/60Hz   |
| Operation temperature | -20°C to +60°C |
| Storage temperature   | -45°C to +85°C |
| RF Power Dissipation  | 0dBm           |

**Electronic Characteristics** 

#### 2-1. Typical frequency response

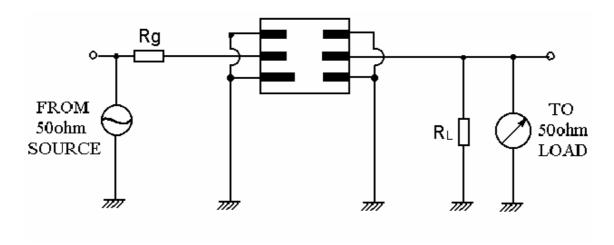


#### 2-2. Electrical characteristics

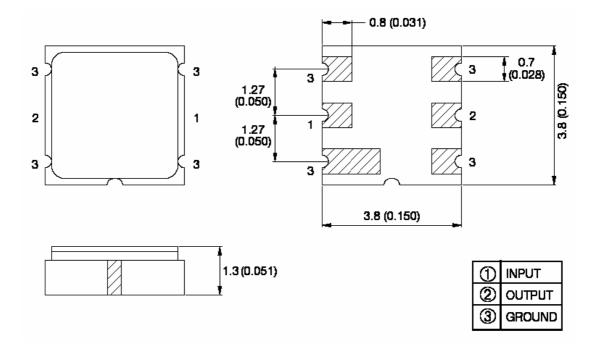
| Part number                     | F422CS4      | Unit |
|---------------------------------|--------------|------|
| Center frequency(Fo)            | 422.0        | MHz  |
| Insertion loss                  |              |      |
| Fo-100MHz~F0-40.8MHz            | 50 min.      | dB   |
| At F0                           | 4.5 max.     | ub   |
| Fo+40.8MHz~Fo+100MHz            | 50 min.      |      |
| Passband ripple                 | 2.0max.      | dB   |
| Passband Width                  | +/- 8.0 min. | dB   |
| Input/Output Impedance(Nominal) | 50//0        | Ω/pF |

(Note: Operating temperature Range:-20°C to +60°C)

#### 3. TEST CIRCUIT



# 4. DIMENSION



# 5. ENVIRONMENTAL CHARACTERISTICS

#### 5-1 Temperature cycling

Subject the device to a low temperature of -40  $^{\circ}$ C for 30 minutes. Following by a high temperature of +25  $^{\circ}$ C for 5 Minutes and a higher temperature of +85  $^{\circ}$ C for 30 Minutes. Then release the device into the room conditions for 1 to 2 hours prior to the measurement. It shall meet the specifications in table 1.

#### 5-2 Resistance to solder heat

Submerge the device terminals into the solder bath at  $260^{\circ}$ C  $\pm 5^{\circ}$ C for  $10\pm 1$  sec. Then release the device into the room conditions for 4 hours. It

shall meet the specifications in table 1.

#### 5-3 Solderability

Submerge the device terminals into the solder bath at  $245^{\circ}$ C  $\pm 5^{\circ}$ C for 5s, More than 95% area of the soldering pad must be covered with new solder. It shall meet the specifications in table 1.

#### 5-4 Mechanical shock

Drop the device randomly onto the concrete floor from the height of 1 m 3 times. the filter shall fulfill the specifications in table 1.

#### 5-5 Vibration

Subject the device to the vibration for 2 hour each in x,y and z axes with the amplitude of 1.5 mm at 10 to 55 hz. The filter shall fulfill the specifications in table 1.

#### 6. REMARK

#### 6.1 Static voltage

Static voltage between signal load & ground may cause deterioration & destruction of the component. Please avoid static voltage.

#### 6.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning

#### 6.3 Soldering

Only leads of component may be soldered. Please avoid soldering another part of component.

# 7. Packing

#### 7.1 Dimensions

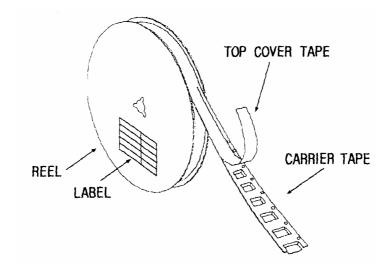
- (1) Carrier Tape: Figure 1
- (2) Reel: Figure 2
- (3) The product shall be packed properly not to be damaged during transportation and storage.

#### 7.2 Reeling Quantity

```
1000 pcs/reel 7" 3000 pcs/reel 13"
```

#### 7.3 Taping Structure

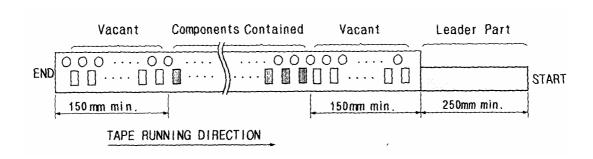
(1) The tape shall be wound around the reel in the direction shown below.



#### (2) Label

| Device Name       |  |
|-------------------|--|
| User Product Name |  |
| Quantity          |  |
| Lot No.           |  |

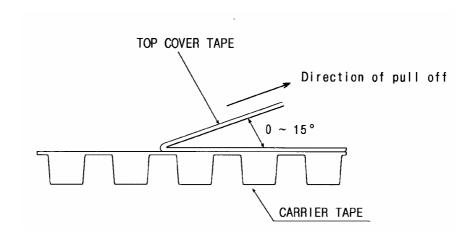
(3) Leader part and vacant position specifications.



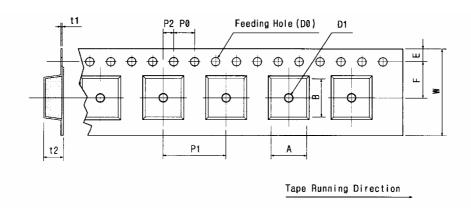
# 8. TAPE SPECIFICATIONS

- 8.1 Tensile Strength of Carrier Tape: 4.4N/mm width
- 8.2 Top Cover Tape Adhesion (See the below figure)
  - (1) pull off angle:  $0\sim15^{\circ}$
  - (2) speed: 300mm/min.

# (3) force: 20~70g



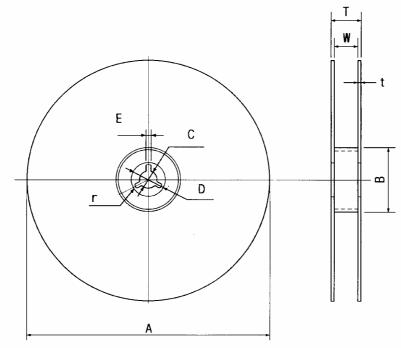
[Figure 1] Carrier Tape Dimensions



|       |       |       |       |       |       |       |            | [Unit:mm]  |       |       |       |
|-------|-------|-------|-------|-------|-------|-------|------------|------------|-------|-------|-------|
| W     | F     | Е     | P0    | P1    | P2    | D0    | D1         | t1         | t2    | A     | В     |
| 12.00 | 5.50  | 1.75  | 4.00  | 8.00  | 2.00  | Ø1.50 | Ø1.0       | 0.25       | 1.65  | 4.04  | 4.10  |
| ±0.30 | ±0.10 | ±0.10 | ±0.10 | ±0.10 | ±0.10 |       | $\pm 0.25$ | $\pm 0.05$ | ±0.10 | ±0.10 | ±0.10 |

[Figure 2]

[Unit:mm]



| A         | В         | C         | D         | Е         | W         | t    | r    |
|-----------|-----------|-----------|-----------|-----------|-----------|------|------|
| Ø330      | Ø100      | Ø13       | 021       | 2         | 13        | 3    | 1.0  |
| $\pm 1.0$ | $\pm 0.5$ | $\pm 0.5$ | $\pm 0.8$ | $\pm 0.5$ | $\pm 0.3$ | max. | max. |